

6367254 MOTOROLA SC (XSTRS/R F)

96D 80563 DT-33-11

MOTOROLA SEMICONDUCTOR TECHNICAL DATA

**BD185
BD187
BD189**

PLASTIC MEDIUM POWER SILICON NPN TRANSISTOR

... designed for use in 5 to 10 Watt audio amplifiers utilizing complementary or quasi complementary circuits.

- DC Current Gain— $h_{FE} = 40$ (Min) @ $I_C = 0.5$ Adc
- BD 185, 187, 189 are complementary with BD 186, 188, 190

4 AMPERE POWER TRANSISTOR

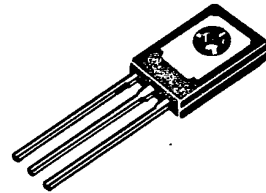
NPN SILICON

**30, 45, 60 VOLTS
40 WATTS**

MARCH 1970—E-003

MAXIMUM RANGS

Rating	Symbol	Type	Value	Unit
Collector-Emitter Voltage	V_{CEO}	BD 185 BD 187 BD 189	30 45 60	Vdc
Collector-Base Voltage*	V_{CBO}	BD 185 BD 187 BD 189	40 55 70	Vdc
Emitter-Base Voltage	V_{EBO}		5	Vdc
Collector Current	I_C		4.0	Adc
Base Current	I_B		2.0	Adc
Total Device Dissipation $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D		40 320	Watts mW/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}		-65 to +150	$^\circ\text{C}$



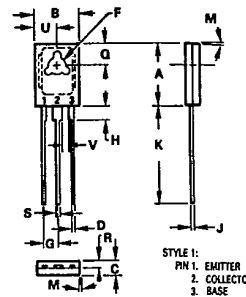
THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	θ_{JC}	3.12	$^\circ\text{C/W}$

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Type	Min	Max	Unit
Collector-Emitter Sustaining Voltage* ($I_C = 0.1$ Adc, $I_B = 0$)	BV_{CEO}	BD 185 BD 187 BD 189	30 45 60	—	Vdc
Collector Cutoff Current ($V_{CB} = 40$ Vdc, $I_E = 0$) ($V_{CB} = 55$ Vdc, $I_E = 0$) ($V_{CB} = 70$ Vdc, $I_E = 0$)	I_{CBO}	BD 185 BD 187 BD 189	—	0.1 0.1 0.1	mAdc
Emitter Cutoff Current ($V_{BE} = 5.0$ Vdc, $I_C = 0$)	I_{EBO}		—	1.0	mAdc
DC current Gain ($I_C = 0.5$ A, $V_{CE} = 2$ V) ($I_C = 2$ A, $V_{CE} = 2$ V)	h_{FE}		40 15	—	
Collector-Emitter Saturation Voltage* ($I_C = 2$ Adc, $I_B = 0.2$ Adc)	$V_{CE(sat)}$		—	1.0	Vdc
Base-Emitter On Voltage* ($I_C = 2$ Adc, $V_{CE} = 2.0$ Vdc)	$V_{BE(on)}$		—	1.5	Vdc
Current-Gain-Bandwidth Product ($I_C = 1.0$ Adc, $V_{CE} = 10$ Vdc, $f = 1.0$ MHz)	f_T		2.0	—	MHz

* Pulse Test: Pulse Width ≤ 300 μs , Duty Cycle $\leq 2.0\%$.



NOTES
1. MT = MAIN TERMINAL
2. LEADS, TRUE POSITIONED WITHIN 0.25mm (0.010) DIA TO DIM A & S AT MAXIMUM MATERIAL CONDITION.

MILLIMETERS		INCHES		
DIM	MIN	MAX	MIN	MAX
A	10.85	11.54	0.427	0.454
B	7.50	7.74	0.295	0.305
C	2.42	2.66	0.095	0.105
D	0.51	0.65	0.020	0.026
F	2.33	3.17	0.115	0.125
G	2.77	2.66	0.091	0.093
H	1.27	2.41	0.050	0.095
J	0.39	0.63	0.015	0.025
K	14.61	18.63	0.575	0.655
M	3 TYP		3 TYP	
Q	3.75	4.51	0.148	0.158
R	1.15	1.39	0.045	0.055
S	0.64	0.88	0.025	0.035
U	3.89	3.93	0.145	0.155
V	1.02	—	0.040	—

CASE 77-05
TO-126

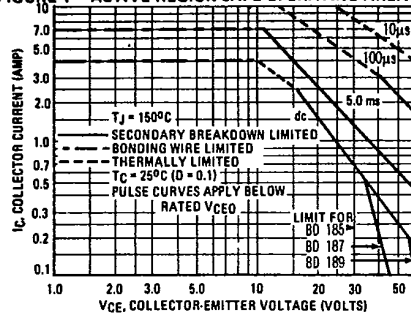
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96D 80564 D

BD185, BD187, BD189

T-33-11

FIGURE 1 - ACTIVE-REGION SAFE OPERATING AREA



The Safe Operating Area Curves indicate I_C - V_{CE} limits below which the device will not enter secondary breakdown. Collector load lines for specific circuits must fall within the applicable Safe Area to avoid causing a catastrophic failure. To insure operation below the maximum T_j , power-temperature derating must be observed for both steady state and pulse power conditions.

FIGURE 2 - COLLECTOR SATURATION REGION

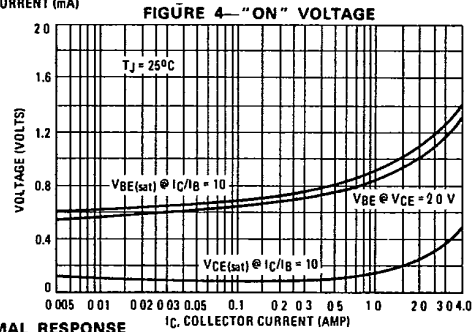
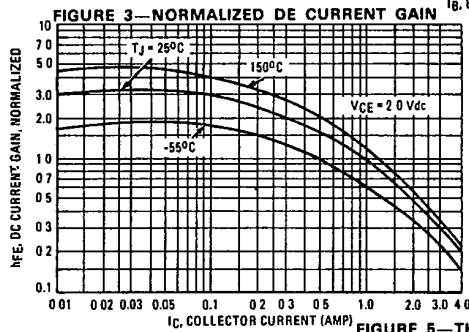
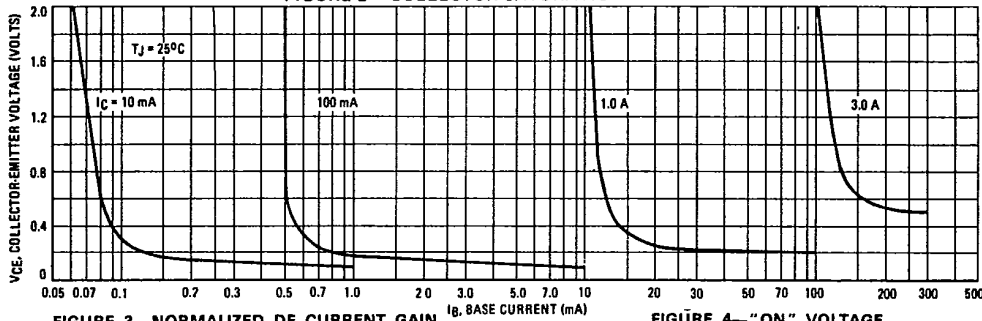


FIGURE 5 - THERMAL RESPONSE

